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BCD-to-Decimal Decoder

High-Voltage Types (20-Volt Rating)

■ CD4028B types are BCD-todecimal or binary-to-octal decoders consisting of buffering on all 4 inputs, decodinglogic gates, and 10 output buffers. A BCD code applied to the four inputs, A to D, results in a high level at the selected one of 10 decimal decoded outputs. Similarly, a 3-bit binary code applied to inputs A through C is decoded in octal code at output 0 to 7 if D = "0". High drive capability is provided at all outputs to enhance dc and dynamic performance in high fan-out applications.

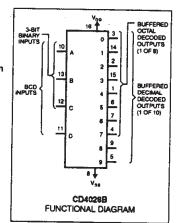
The CD4028B-Series types are supplied in 16-lead hermetic dual-in-line ceramic packages (D and F suffixes), 16-lead dual-in-line plastic packages (E suffix), and in chip form (H suffix).

Features:

- BCD-to-decimal decoding or binary-to-octal decoding
- High decoded output drive capability
- "Positive logic" inputs and outputs....
 "Positive logic" inputs and outputs go high on selection
- Medium-speed operation, . . . tpHL, tpLH = 80 ns (typ.) @ VDD = 10 V
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (over full packagetemperature range):
 - 1 V at V_{DD} = 5 V
 - 2 V at V_{DD} ≖ 10 V
 - 2.5 V at V_{DD} = 15 V
- 5-V, 10-V, and 15-V parametric ratings
 Meets all requirements of JEDEC
- Tentative Standard No. 138, "Standard Specifications for Description of 'B' Series CMOS Devices''

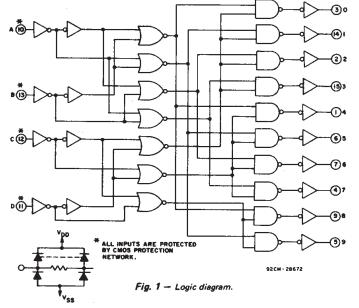
Applications:

- Code conversion
 Indicator-tube decoder
- Address decoding—memory selection control



	<i>_</i> _	_	i i
4 —	10	- 16	
2 —	2	15	- 3
0	3	-14	⊢ ।
7 -	4	13	— e
9 —	5	12	c
5	6	- 14	D
6 —	7	ю	- A
ss —	8	9	6
	L		
		9	205-24471

Top View TERMINAL DIAGRAM



MAXIMUM RATINGS, Absolute-Maximum Values:

 DC SUPPLY-VOLTAGE RANGE, (VDD)

 Voltages referenced to VSS Terminal)

 INPUT VOLTAGE RANGE, ALL INPUTS

 DC INPUT CURRENT, ANY ONE INPUT

 -0.5V to VDD +0.5V

 DC INPUT CURRENT, ANY ONE INPUT

 $\pm 10mA$

 POWER DISSIPATION PER PACKAGE (PD):

 For T_A = -55°C to +100°C

 500mW

 For T_A = +100°C to +125°C

 DEVICE DISSIPATION PER OUTPUT TRANSISTOR

 FOR T_A = FULL PACKAGE-TEMPERATURE RANGE (All Package Types)

 100mW

 OPERATING-TEMPERATURE RANGE (T_A)

 STORAGE TEMPERATURE RANGE (T_{stg})

 LEAD TEMPERATURE (DURING SOLDERING):

 At distance 1/16 ± 1/32 inch (1.59 ± 0.79mm) from case for 10s max

TABLE I - TRUTH TABLE

D	С	В	A	0	1	2	3	4	5	6	7	8	9
0	0	0	0	1	0	0	0	0	0	0	0	0	0
0	0	0	1	0	1	0	0	0	0	0	0	0	0
0	0	Ŧ	0	0	0	1	0	0	0	0	0	0	0
0	0	1	1	0	0	0	1	0	0	0	0	0	0
0	1	0	0	0	0	0	0	1	0	0	0	0	0
0	1	0	1	0	0	0	0	0	1	0	0	0	0
0	1	1	0	0	0	0	0	0	0	1	0	0	0
0	1	1	1	0	0	0	0	0	0	0	1	0	0
1	0	0	0	0	0	0	0	0	0	0	0	1	0
1	0	0	1	0	0	0	0	0	0	0	0	0	1
1	0	1	0	0	0	0	0	0	0	0	0	0	0
1	0	1	1	0	0	0	0	0	0	0	0	0	0
1	1	0	0	0	0	0	0	0	0	0	0	0	0
1	1	0	1	0	0	0	0	0	0	0	0	0	0
1	Ŧ	1	0	0	0	0	0	0	0	0	0	0	0
1	1	1	1	0	0	0	0	0	0	0	0	0	0

CD4028B Types

RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

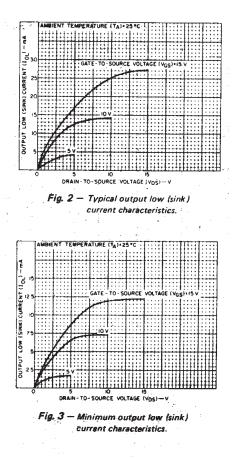
CHARACTERISTIC	· L	UNITS		
	MIN.	MAX.	1	
Supply Voltage Range (For T _A = Full Package				
Temperature Range)	3	18	· · v	

CHARACTER-	CON	DITIO	VS	LIMI	LIMITS AT INDICATED TEMPERATURES (°C)									
ISTIC	Vo	VIN	VDD						+25		UNITS			
	(V) .	(V)	(V)	-55	-40	+85	+125	Min.	Typ.	Max.]			
Quiescent Device	_	0,5	5	5	5	150	150	- :	0.04	5				
Current,	-	0,10	10	10	10	300	300	-	.0.04	10	μA			
IDD Max.	-	0,15	15	20	20	600	600		0.04	20				
		0,20	20	100	100	3000	3000	-	0,08	100	1			
Output Low	0.4	0,5	5	0.64	0.61	0,42	0,36	0.51	1	-	<u> </u>			
(Sink) Current	0,5	0,10	10	1.6	1.5	1,1	0.9	1.3	2.6		1			
IOL Min.	1,5	0,15	15	4.2	4	2.8	2.4	34	6.8	-	1 a 4			
Output High (Source) Current, IOH Min.	4.6	0,5	5	-0.64	-0,61	-0.42	-0.36	-0.51	1	-	mA			
	2.5	0,5	· 5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	-				
	9.5	0,10	10	-1.6	-1,5	-1.1	-0.9	-1.3	-2.6	-				
	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	- 6.8	-				
Output Voltage:	-	0,5	5		0	.05		_	0	0.05				
Low-Level, Voi Max.	-	0,10	10		0	.05		-	0	0.05				
*UL max.	-	0,15	15		0	.05		-	0	0.05				
Output Voltage:	-	0,5	5		4	95		4.95	5	-	v			
High Level, VOH Min.	-	0,10	10		9	.95		9.95	10					
VOH Min.	-	0,15	15		14	.95		14.95	15	-				
Input Low	0.5, 4.5	-	5		1	.5		-	-	1.5				
Voltage, Vij Max,	1, 9	_	10			3		_	-	3				
VIL Max.	1.5,13.5	-	15			4		-	-	4				
Input High	0.5, 4,5	-	5		3	.5		3,5	-	-	v			
Voltage,	1, 9	-	10			7		7	-	-				
VIH Min.	1.5,13,5	-	15		1	1		11	-	-				
Input Current IIN Max.	-	0,18	18	±0,1	±0.1	±1	±1	-	±10 ⁻⁵	±0.1	μA			

STATIC ELECTRICAL CHARACTERISTICS



CHARACTERISTIC	TEST CONDITIONS	LIM		
CHARACTERISTIC	V _{DD} (V)	Тур.	Max.	UNITS
Propagation Delay Time:	5	175	350	ns
^t PHL ^{, t} PLH	10	80	160	-
	15	60	120	
	5	100	200	1
Transition Time	10	50	100	ns
^t THL ^{, t} TLH	15	40	80	
Input Capacitance, CIN	_	5	7.5	рF



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COMMERCIAL CMOS HIGH VOLTAGE ICs

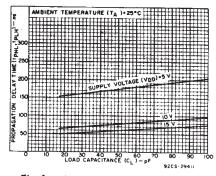


Fig. 4 — Typical propagation delay time as a function of load capacitance.

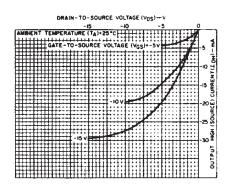


Fig. 5 – Typical output high (source) current characteristics.

TABLE II - CODE CONVERSION CHART

			INPUT CODES																					
Hexa - Decimal			D	ecima)																			
INF	יטי	S	IT IARY	4-BIT GRAY	EXCESS-3	EXCESS-3 GRAY	AIKEN	2-1					I	ou	ТР	UT	N	JM	8 E	R				
DC	B	Α	848 BIN	4 6 8 6	Ě	Щ. Х. С. Х. С.	AIM	4.2.2.1	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
0 0	0	0	0	0			0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
0 0	0	1	1	1			1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0
0 0	1	0	2	3		0	2	2	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0
0 0	1	1	3	2	0	3	3		0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	ō
0 1	0	0	- 4-	7	1	4	4		0	0	0	0	1	0	0	0	0	Ó	0	0	0	0	0	0
0 1	0	1	5	6	2			3	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0
0 1	1	0	6	4	3	1		4	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0
0 1	1	1	7	5	4	2			0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
1 0	0	0	8	15	5				0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
1 0	0	1	9	14	6			5	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
1 0	1	0	10	12	7	9		6	0	0	0	0	0	0	0	0	0	0	1	Û	0	0	0	0
1 0	1	1	11	13	8		5		0	0	0	0	0	0	Ó	0	0	0	0	1	0	0	0	0
1 1	0	0	12	8	9	5	6		0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0
1 1	0	1	13	9		6	7	7	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0
1 1	1	0	14	11		8	8	8	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
1 1	1	1	15	10		7	9	9	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1

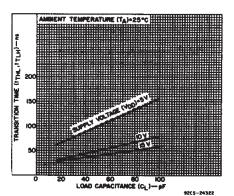


Fig. 8 — Typical transition time as a function of load capacitance.

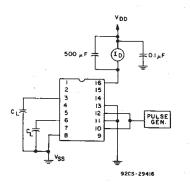


Fig. 10 - Dynamic power dissipation test circuit.

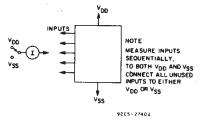
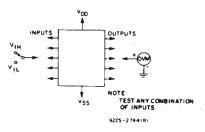
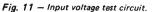
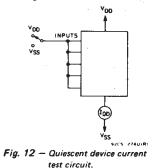


Fig. 9 - Input current test circuit.







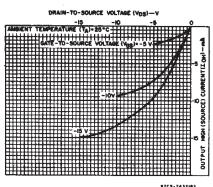
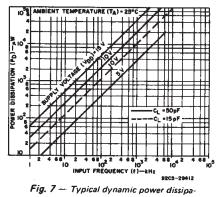
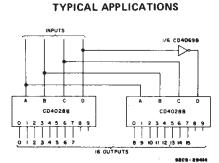
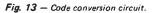


Fig. 6 — Minimum output high (source)



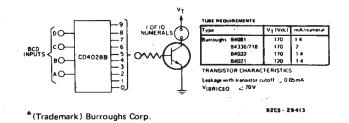
tion as a function of input frequency.

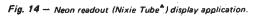


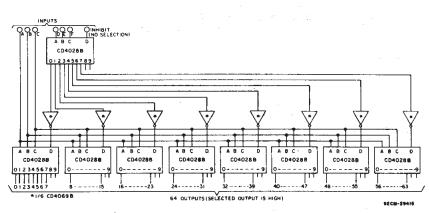


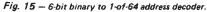
The circuit shown in Fig.13 converts any 4bit code to a decimal or hexadecimal code. Table 2 shows a number of codes and the decimal or hexadecimal number in these codes which must be applied to the input terminals of the CD4028B to select a particular output. For example: in order to get a high on output No. 8 the input must be either an 8 expressed in 4-Bit Binary code, a 15 expressed in 4-Bit Gray code, or a 5 expressed in Excess-3 code.

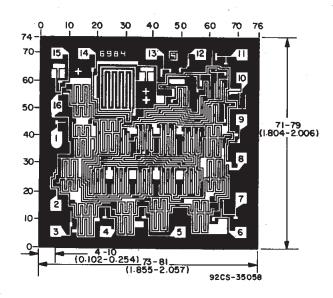
3-82

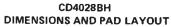












Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch) .

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